2024-05-20 Contact Name Title - Contact Product-Env-Stewards Authorized Representative*  Title - Representative Product-Enviro Compliance Title - Representative Phone - Representative*  Email - Representative Email - Rep	Note: if the item is an assembly with low facturer has engineering responsibility.		
Company name* Company unique ID Unique ID Authority Response E  nsemi  Contact Name Title - Contact Product-Env-Stewards Product Enviro Compliance Authorized Representative* Product-Env-Stewards Product Enviro Compliance NA Product-Env-Stewards Product-Env-S	formation		
Insemi Contact Name Title - Contact Product-Env-Stewards Authorized Representative* Title - Representative Title - Representative Product-Env-Stewards Produ			
Contact Name Product-Env-Stewards Product Enviro Compliance Authorized Representative* Product-Env-Stewards Produc	Response Date*		
Product-Env-Stewards Authorized Representative* Title - Representative Product-Env-Stewards Product-Env-Stewards Product Enviro Compliance Requester Item Number Mfr Item Number Mfr Item Name Product-Env-Stewards NA Product-Env-Stewards Requester Item Number Mfr Item Number Mfr Item Name Product-Env-Stewards NA			
Title - Representative Phone - Representative*  Product-Env-Stewards Product Enviro Compliance NA Product-E  Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Wei  NOIX2SF8000B-LTI XGS8MP, 12port, Color 7.3D 2024-05-20 281  Manufacturing Proccess Information	Email - Contact*		
Product-Env-Stewards  Requester Item Number  Mfr Item Number  Mfr Item Name  Moix2SF8000B-LTI  Manufacturing Proccess Information  Product-Env-Stewards  NA  Product-Env-Stewards  NA  Effective Date  Version  Manufacturing Site  Wei  2024-05-20  281	Product-Env-Stewards@onsemi.com		
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Wei NOIX2SF8000B-LTI XGS8MP, 12port, Color 7.3D 2024-05-20 281  Manufacturing Proccess Information	Email - Representative*		
NOIX2SF8000B-LTI XGS8MP, 12port, Color 7.3D 2024-05-20 281  Anufacturing Proccess Information	Product-Env-Stewards@onsemi.com		
Innufacturing Proccess Information	ght* UOM Unit Type		
	mg Each		
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature			
	Number of Reflow Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn) 4 245 C 30 seconds	3		
omments			

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct at it in member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	1947.74	mg	Supplier	Cobalt (Co)	7440-48-4		0.1948	mg
			Supplier	Molybdenum (Mo)	7439-98-7		0.1948	mg
			Supplier	Tungsten (W)	7440-33-7		23.3729	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		122.7076	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		1725.6976	mg
			В	Nickel (Ni)	7440-02-0		5.4537	mg
			Supplier	Gold (Au)	7440-57-5		3.8955	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		66.2232	mg
Die	198.5	mg	Supplier	Silicon (Si)	7440-21-3		198.5	mg
Die Attach	20.25	.25 mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		1.0125	mg
			Supplier	Formaldehyde Polymer	9003-36-5		7.0875	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		12.15	mg
Glass Attach Epoxy	9.99	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		0.8591	mg
			Supplier	N-[3- (Trimethoxysilyl)propyl]ethylenediamine	1760-24-3		0.6893	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		4.1558	mg
			Supplier	4,4'-Diaminodiphenyl Sulfone (DDS-4,4')	80-08-0		0.03	mg
			Supplier	Filler (SiO2?C2H6Cl2Si)	68611-44-9		3.996	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2597	mg
Glass Lid /Cap	642.73	642.73 mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		53.9893	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		382.2958	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		52.7039	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		50.9042	mg
			Supplier	Calcium Monoxide (CaO)	1305-78-8		102.8368	mg
Wire Bond - Al	0.24	mg	Supplier	Aluminum (Al)	7429-90-5		0.24	mg